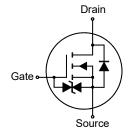
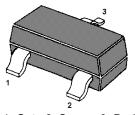
N-Channel Enhancement Mode MOSFET

Features

- · Low gate threshold voltage
- · Low input capacitance
- · Fast switching speed
- Built-in G-S Protection Diode
- Typical ESD Protection HBM Class 2

Classification	Voltage Range(V)
0A	< 125
0B	125 to < 250
1A	250 to < 500
1B	500 to < 1000
1C	1000 to < 2000
2	2000 to < 4000
3A	4000 to < 8000
3B	≥ 8000





 Gate 2. Source 3. Drain SOT-23 Plastic Package

Applications

- Portable appliances
- · Battery management

Absolute Maximum Ratings (at T_a = 25℃ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	± 8	V
Drain Current	ID	630	mA
Peak Drain Current, Pulsed 1)	I _{DM}	3	Α
Power Dissipation ²⁾	P _D	280	mW
Operating Junction and Storage Temperature Range	Tj, Tstg	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient 2)	Reja	446	°C/W

 $^{^{1)}}$ Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ = 150°C.



²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad in still air.

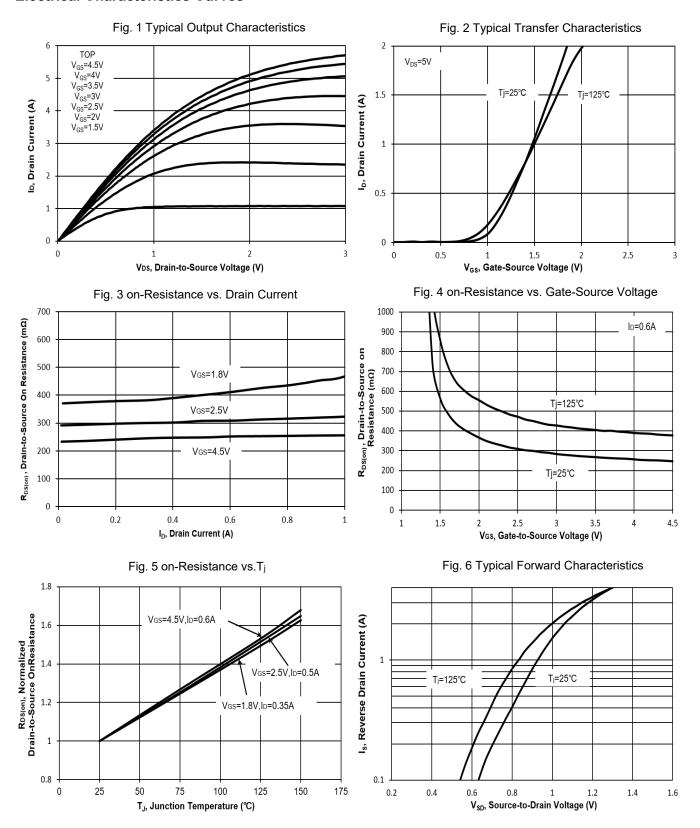
MMFTN1012BK

Characteristics at T_a = 25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit	
STATIC PARAMETERS						
Drain-Source Breakdown Voltage at I _D = 250 μA	BV _{DSS}	20	-	-	V	
Drain-Source Leakage Current at V _{DS} = 20 V	I _{DSS}	-	-	100	nA	
Gate Leakage Current at $V_{GS} = \pm 8 \text{ V}$	Igss	-	-	± 1	μΑ	
Gate-Source Threshold Voltage at V_{DS} = V_{GS} , I_D = 250 μA	V _{GS(th)}	0.5	-	1	V	
Drain-Source On-State Resistance at V_{GS} = 4.5 V, I_D = 600 mA at V_{GS} = 2.5 V, I_D = 500 mA at V_{GS} = 1.8 V, I_D = 350 mA	R _{DS(on)}			0.4 0.5 0.7	Ω	
DYNAMIC PARAMETERS		_	_	_		
Forward transfer admittance at V_{DS} = 10 V, I_D = 400 mA	g FS	-	1.4	-	S	
Input Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 10 \text{ V}$, $f = 1 \text{ MHz}$	C _{iss}	ı	72	ı	pF	
Output Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 10 \text{ V}$, $f = 1 \text{ MHz}$	Coss	-	14	-	pF	
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 10 \text{ V}$, $f = 1 \text{ MHz}$	C _{rss}	-	12	-	pF	
Gate charge total at V_{DS} = 10 V, I_D = 1 A, V_{GS} = 4.5 V at V_{DS} = 10 V, I_D = 1 A, V_{GS} = 2.5 V	Q_g		1.17 0.65		nC	
Gate to Source Charge at V_{DS} = 10 V, I_D = 1 A, V_{GS} = 4.5 V	Q _{gs}	-	0.3	-	nC	
Gate to Drain Charge at V_{DS} = 10 V, I_D = 1 A, V_{GS} = 4.5 V	Q_{gd}	-	0.2	-	nC	
Turn-On Delay Time at V_{GS} = 4.5 V, V_{DS} = 10 V, I_D = 0.5 A, R_g = 10 Ω	t _{d(on)}	ı	12	ı	nS	
Turn-On Rise Time at V_{GS} = 4.5 V, V_{DS} = 10 V, I_D = 0.5 A, R_g = 10 Ω	t _r	-	6	-	nS	
Turn-Off Delay Time at V_{GS} = 4.5 V, V_{DS} = 10 V, I_D = 0.5 A, R_g = 10 Ω	t _{d(off)}	-	13	-	nS	
Turn-Off Fall Time at V_{GS} = 4.5 V, V_{DS} = 10 V, I_D = 0.5 A, R_g = 10 Ω	t _f	-	10	-	nS	
Body-Diode PARAMETERS						
Diode Forward Voltage at I _S = 0.5 A, V _{GS} = 0 V	V _{SD}	-	-	1.3	V	
Body-Diode Continuous Current	Is	-	-	630	mA	
Body Diode Reverse Recovery Time at $I_S = 1$ A, di/dt = 100 A / μ s	t _{rr}	-	5.2	-	nS	
Body Diode Reverse Recovery Charge at $I_S = 1$ A, di/dt = 100 A / μ s	Qrr	-	1.2	-	nC	



Electrical Characteristics Curves





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Electrical Characteristics Curves

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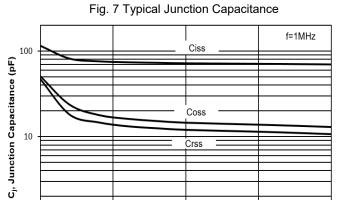


Fig. 8 Drain-Source Leakage Current vs. T_j

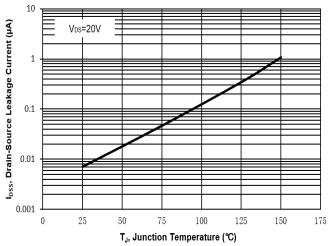


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature

10

VDS, Drain-Source Voltage (V)

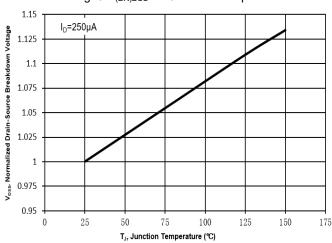


Fig. 10 Gate Threshold Variation vs. T_j

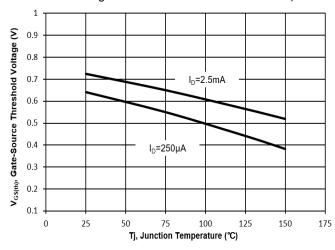
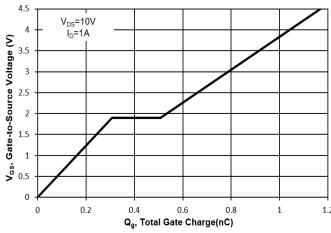


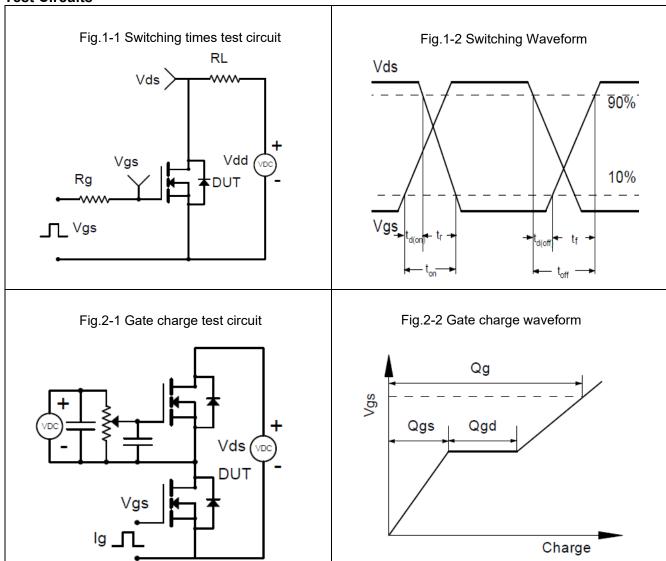
Fig. 11 Gate Charge





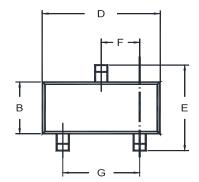
20

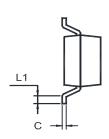
Test Circuits

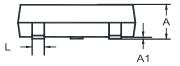


Package Outline (Dimensions in mm)

SOT-23

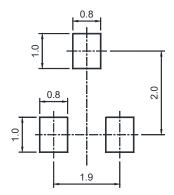






Unit	Α	A1	В	С	D	Е	F	G	L	L1
na na	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint



Packing information

Package	Tape Width	Pit	tch	Reel	Size		
	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity	
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

Marking information

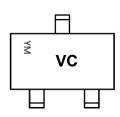
" VC " = Part No.

" YM " = Date Code Marking

" Y " = Year

" M " = Month

Font type: Arial



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